

02-22-1999

FORM PTO-1595

1-31-92



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R SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Attorney Docket No: TSAI113190

To the Honorable Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.

1. Names of conveying parties:

Chia-Ching Tung, Cheng-Lung Lu and Hung-Yi Luo

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party:

Name: Vanguard International Semiconductor CorporationAddress: 123, Park Ave-3rd., Science-Based Industrial ParkCity: Hsinchu Province: TaiwanCountry: R.O.C.

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution dates: January 16, 1999 by Chia-Ching Tung,
January 18, 1999 by Cheng-Lung Lu, and January 14, 1999 by
Jung-Yi LuoAdditional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application number(s) or patent number(s):

A. Patent Application No(s).

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ NoIf this document is being filed together with a new application, the execution date of the application is: January 18, 1999

5. Name and address of party to whom correspondence concerning document should be mailed:

Chun M. Ng, Esq.
CHRISTENSEN O'CONNOR
JOHNSON & KINDNESS^{PLLC}
1420 Fifth Avenue
Suite 2800
Seattle, WA 98101-2347
(206) 682-81006. Total number of applications and patents involved: 17. Total fee (37 C.F.R. 3.41):\$ 40.00Check No. 103203 in the
amount of \$40.00 is enclosed.

8. The Commissioner is hereby authorized to charge any fees under 37 C.F.R. §§ 1.16 and 1.17 which may be required during the entire pendency of the application, or credit any overpayment, to Deposit Account Number 03-1740.

DO NOT USE THIS SPACE

9. Statement and signature:

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Chun M. Ng

Name of Attorney or Agent

Registration No. 36,878

Direct Dial (206) 224-0719

Signature

February 11, 1999

Date

Total number of pages including cover sheet, attachments and document: 3

OMB No. 0651-0011 (exp. 4/94)

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PATENT
REEL: 9763 FRAME: 0173

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) METHOD AND PATTERN FOR AVOIDING MICRO-LOADING EFFECT IN AN ETCHING PROCESS

The PATENT RIGHTS referred to in this agreement are:

(check one) ☒ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

☐ U.S. patent application Serial No. _____, filed _____

☐ a U.S. patent application based on PCT International Application

No. _____ filed on (date) _____ (U.S. patent application Serial No. _____, if known).

☐ U.S. patent No. _____, issued _____

The PATENT RIGHTS also include all divisions reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) ☒ U.S. patent rights only.

☐ Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) VANGUARD INTERNATIONAL SEMICONDUCTOR CORPORATION

(Address) 123, PARK AVE-3RD., SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN, R.O.C.

The ASSIGNEE is:

(check one) ☐ An individual.

☐ A Partnership.

☒ A Corporation of TAIWAN, R.O.C. (specify state or country)

☐ (other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO

ASSIGNEE: VANGUARD INTERNATIONAL SEMICONDUCTOR CORPORATION

INVENTION TITLE: METHOD AND PATTERN FOR AVOIDING MICRO-LOADING
EFFECT IN AN ETCHING PROCESS

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been excuted.

<u>Chia-Ching TUNG</u> Name of sole or first inventor	<u>Chia Ching Tung</u> Signature	<u>1/14/99'</u> Date
<u>Cheng-Lung LU</u> Name of second inventor, if any	<u>Cheng-Lung Lu</u> Signature	<u>1/18/99'</u> Date
<u>Hung-Yi LUO</u> Name of third inventor, if any	<u>Hung-Yi Luo</u> Signature	<u>1/14 1999</u> Date
<u> </u> Name of fourth inventor, if any	<u> </u> Signature	<u> </u> Date
<u> </u> Name of fifth inventor, if any	<u> </u> Signature	<u> </u> Date
<u> </u> Name of sixth inventor, if any	<u> </u> Signature	<u> </u> Date
<u> </u> Name of seventh inventor, if any	<u> </u> Signature	<u> </u> Date
<u> </u> Name of eighth inventor, if any	<u> </u> Signature	<u> </u> Date